# BY459DX-1500, BY459DX-1500S

### **FEATURES**

- Low forward volt drop
- · Fast switching
- Soft recovery characteristic
- High thermal cycling performance
  Isolated mounting tab



PINNING

PIN

1

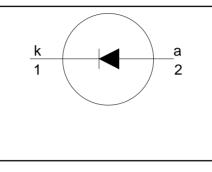
2

tab

cathode

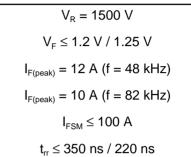
anode

isolated



DESCRIPTION

### QUICK REFERENCE DATA



case

Ο 0

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2

С

SOD117

### **GENERAL DESCRIPTION**

Glass-passivated double diffused rectifier diode featuring fast forward recovery and low forward recovery voltage. The device is intended for use in HDTV receivers and multi-sync monitor horizontal deflection circuits.

The BY459DX series is supplied in the conventional leaded SOD117 package.

### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	M	AX.	UNIT
$V_{RSM}$	Peak non repetitive reverse voltage		-	15	600	V
$V_{RRM}$	Peak repetitive reverse voltage		-	15	00	V
V <sub>RWM</sub>	Crest working reverse voltage		-	1300		V
I <sub>F(peak)</sub>	Peak working forward current	f = 48 kHz; f = 82 kHz;	-	<b>-1500</b> 12 -	- <b>1500S</b> - 10	A
I <sub>FRM</sub>	Peak repetitive forward current	t = 100 μs	-	1	00	A
I <sub>F(RMS)</sub>	RMS forward current		-		0	A
I <sub>FSM</sub>	Peak non-repetitive forward current	t = 10 ms t = 8.3 ms sinusoidal; $T_i = 150$ °C prior to surge; with reapplied V <sub>RWM(max)</sub>	-		00 10	A A
${{\sf T}_{{ m stg}}} {{\sf T}_{{ m j}}}$	Storage temperature Operating junction temperature	RWM(max)	-40 -	150 150		°C °C

## BY459DX-1500, BY459DX-1500S

## **ISOLATION LIMITING VALUE & CHARACTERISTIC**

 $T_{hs} = 25$  °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>isol</sub>	R.M.S. isolation voltage from both terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. $\leq$ 65% ; clean and dustfree	-		2500	V
C <sub>isol</sub>	Capacitance from both terminals to external heatsink	f = 1 MHz	-	10	-	pF

### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-hs</sub> R <sub>th j-a</sub>	heatsink	with heatsink compound without heatsink compound in free air.		- - 35	3.6 4.5 -	K/W K/W K/W

### STATIC CHARACTERISTICS

 $T_i = 25$  °C unless otherwise stated

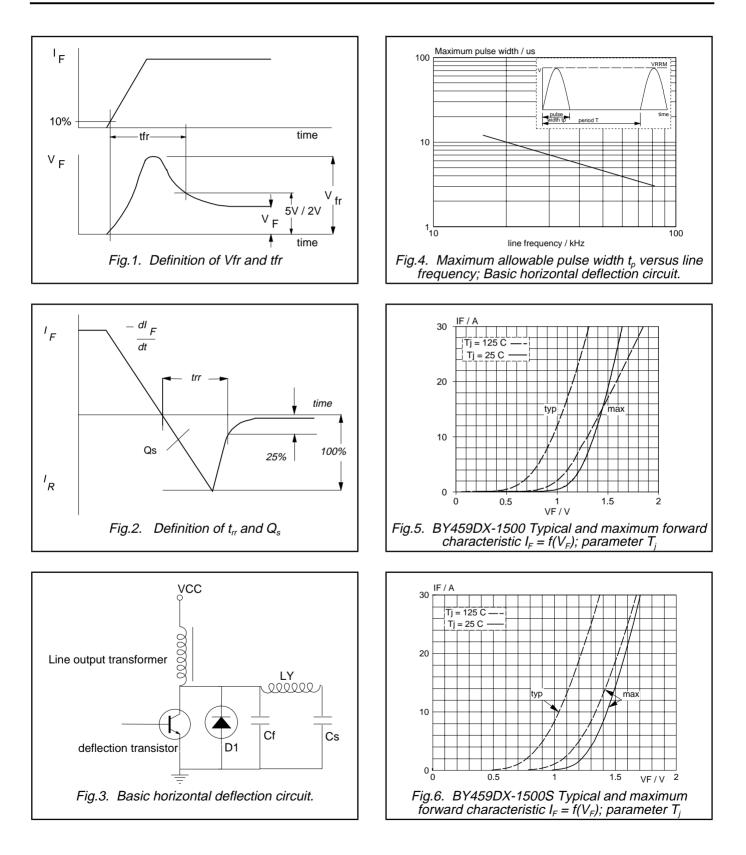
SYMBOL	PARAMETER	CONDITIONS	ΤY	′P.	M	AX.	UNIT
		BY459DX-	1500	1500S	1500	1500S	
V <sub>F</sub>	Forward voltage	I <sub>F</sub> = 6.5 A I <sub>F</sub> = 6.5 A; T <sub>i</sub> = 125 °C	0.95 0.85	1.05 0.95	1.30 1.20	1.35 1.25	V V
I <sub>R</sub>	Reverse current	V <sub>R</sub> = 1300 V V <sub>R</sub> = 1300 V; T <sub>j</sub> = 125 °C	-	250 1	-	250 1	μA mA

## DYNAMIC CHARACTERISTICS

 $T_i = 25$  °C unless otherwise stated

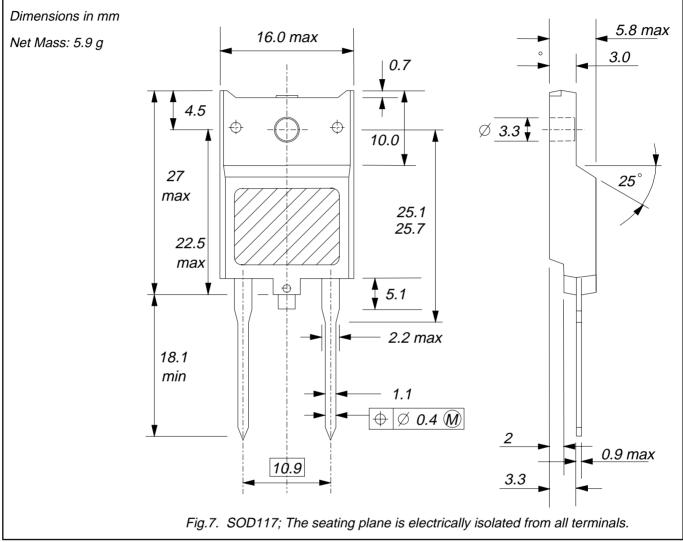
SYMBOL	PARAMETER	CONDITIONS	TYP.		MAX.		UNIT
		BY459DX-	1500	1500S	1500	1500S	
$\begin{array}{c} t_{rr} \\ Q_s \\ V_{fr} \\ t_{fr} \end{array}$	Reverse recovery time Reverse recovery charge Peak forward recovery voltage Forward recovery time	$\begin{array}{l} I_{\text{F}} = 1 \text{ A},  V_{\text{R}} \geq 30  \text{V}; \\ I_{\text{F}} = 2 \text{ A},  \text{-} \text{d}_{\text{F}}/\text{d} \text{t} = 20  \text{A}/\mu \text{s} \\ I_{\text{F}} = 6.5 \text{A},  \text{d}_{\text{F}}/\text{d} \text{t} = 50  \text{A}/\mu \text{s} \\ I_{\text{F}} = 6.5 \text{A},  \text{d}_{\text{F}}/\text{d} \text{t} = 50  \text{A}/\mu \text{s} \end{array}$	0.25 2.0 8.0 170	0.17 0.70 11.0 200	0.35 3.0 14.0 250	0.22 0.95 19.0 300	μs μC V ns

# BY459DX-1500, BY459DX-1500S



## BY459DX-1500, BY459DX-1500S

### **MECHANICAL DATA**



#### Notes

Refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

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#### DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	becification This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					
or more of the limiting val operation of the device at	in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one ues may cause permanent damage to the device. These are stress ratings only and these or at any other conditions above those given in the Characteristics sections of applied. Exposure to limiting values for extended periods may affect device reliability.				
Application information					
Where application inform	ation is given, it is advisory and does not form part of the specification.				
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